

IRF7494PbF

HEXFET® Power MOSFET

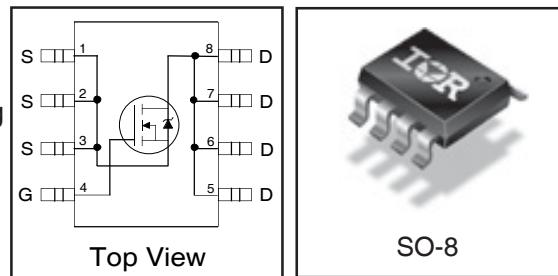
Applications

- High frequency DC-DC converters
- Lead-Free

V_{DSS}	R_{DS(on)} max	I_D
150V	44mΩ@V_{GS} = 10V	5.1A

Benefits

- Low Gate to Drain Charge to Reduce Switching Losses
- Fully Characterized Capacitance Including Effective Coss to Simplify Design, (See App. Note AN1001)
- Fully Characterized Avalanche Voltage and Current



Absolute Maximum Ratings

	Parameter	Max.	Units
V _{DS}	Drain-to-Source Voltage	150	V
V _{GS}	Gate-to-Source Voltage	± 20	
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 10V	5.1	A
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 10V	4.0	
I _{DM}	Pulsed Drain Current ①	40	
P _D @ T _A = 25°C	Maximum Power Dissipation	2.5	W
	Linear Derating Factor	0.02	W/°C
dV/dt	Peak Diode Recovery dV/dt ②	33	V/ns
T _J	Operating Junction and	-55 to + 150	°C
T _{STG}	Storage Temperature Range		

Thermal Resistance

	Parameter	Typ.	Max.	Units
R _{θJL}	Junction-to-Drain Lead ③	—	20	°C/W
R _{θJA}	Junction-to-Ambient (PCB Mount) ③	—	50	

Notes ① through ③ are on page 8

www.irf.com

IRF7494PbF

International
I_R Rectifier

Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	150	—	—	V	V _{GS} = 0V, I _D = 250µA
ΔV _{(BR)DSS} /ΔT _J	Breakdown Voltage Temp. Coefficient	—	0.13	—	V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance	—	35	44	mΩ	V _{GS} = 10V, I _D = 3.1A ④
V _{GS(th)}	Gate Threshold Voltage	2.5	—	4.0	V	V _{DS} = V _{GS} , I _D = 250µA
I _{DSS}	Drain-to-Source Leakage Current	—	—	10	µA	V _{DS} = 120V, V _{GS} = 0V
		—	—	250	µA	V _{DS} = 120V, V _{GS} = 0V, T _J = 125°C
I _{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	V _{GS} = 20V
	Gate-to-Source Reverse Leakage	—	—	-100	nA	V _{GS} = -20V

Dynamic @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
g _{fs}	Forward Transconductance	12	—	—	S	V _{DS} = 50V, I _D = 5.1A
Q _g	Total Gate Charge	—	35	53	nC	I _D = 3.1A
Q _{gs}	Gate-to-Source Charge	—	6.4	—	nC	V _{DS} = 75V
Q _{gd}	Gate-to-Drain ("Miller") Charge	—	13	—	nC	V _{GS} = 10V ④
t _{d(on)}	Turn-On Delay Time	—	9	—	ns	V _{DD} = 75V
t _r	Rise Time	—	10	—	ns	I _D = 3.1A
t _{d(off)}	Turn-Off Delay Time	—	29	—	ns	R _G = 6.8Ω
t _f	Fall Time	—	14	—	ns	V _{GS} = 10V ④
C _{iss}	Input Capacitance	—	1783	—	pF	V _{GS} = 0V
C _{oss}	Output Capacitance	—	222	—	pF	V _{DS} = 25V
C _{rss}	Reverse Transfer Capacitance	—	104	—	pF	f = 1.0MHz
C _{oss}	Output Capacitance	—	886	—	pF	V _{GS} = 0V, V _{DS} = 1.0V, f = 1.0MHz
C _{oss}	Output Capacitance	—	121	—	pF	V _{GS} = 0V, V _{DS} = 120V, f = 1.0MHz
C _{oss} eff.	Effective Output Capacitance	—	189	—	pF	V _{GS} = 0V, V _{DS} = 0V to 120V ⑤

Avalanche Characteristics

	Parameter	Typ.	Max.	Units
E _{AS}	Single Pulse Avalanche Energy ②	—	262	mJ
I _{AR}	Avalanche Current ①	—	3.1	A

Diode Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I _S	Continuous Source Current (Body Diode)	—	—	2.3	A	MOSFET symbol showing the integral reverse p-n junction diode.
I _{SM}	Pulsed Source Current (Body Diode) ①	—	—	40	A	
V _{SD}	Diode Forward Voltage	—	—	1.3	V	T _J = 25°C, I _S = 3.1A, V _{GS} = 0V ④
t _{rr}	Reverse Recovery Time	—	45	—	ns	T _J = 25°C, I _F = 3.1A, V _{DD} = 25V
Q _{rr}	Reverse Recovery Charge	—	93	—	nC	di/dt = 100A/µs ④

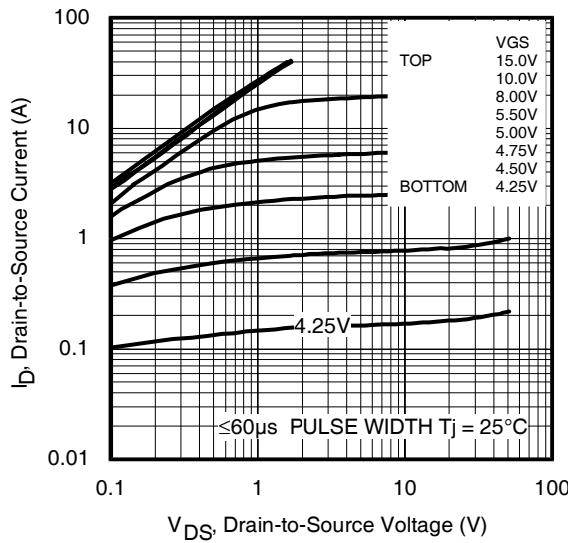


Fig 1. Typical Output Characteristics

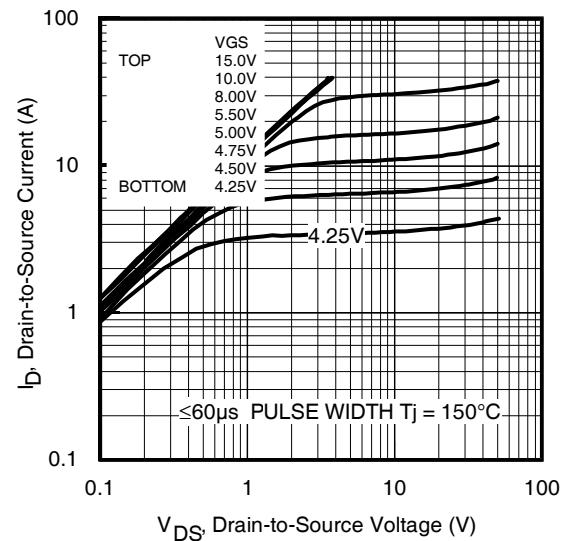


Fig 2. Typical Output Characteristics

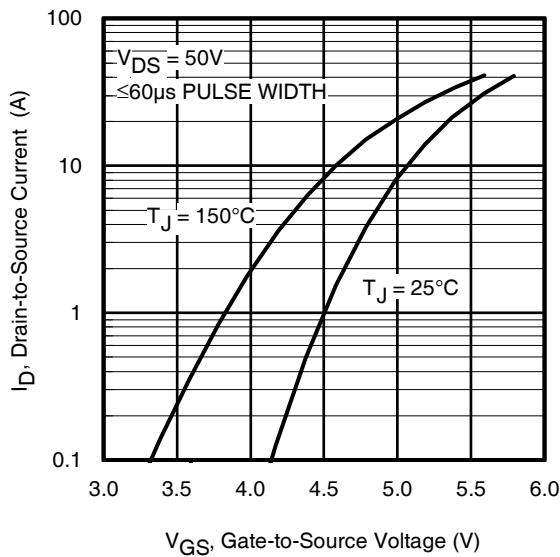


Fig 3. Typical Transfer Characteristics

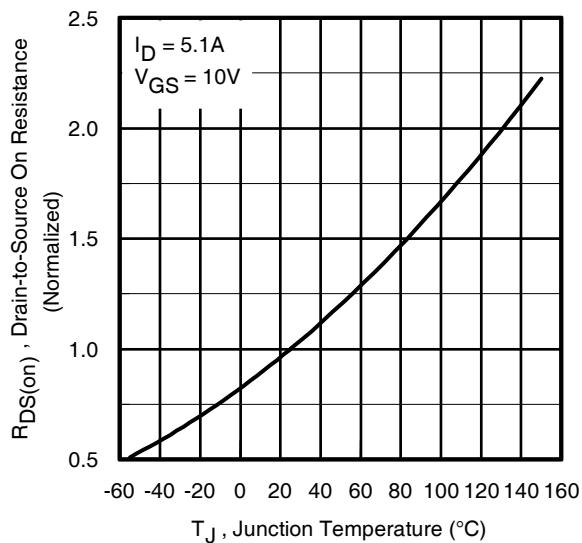


Fig 4. Normalized On-Resistance
vs. Temperature

IRF7494PbF

International
IR Rectifier

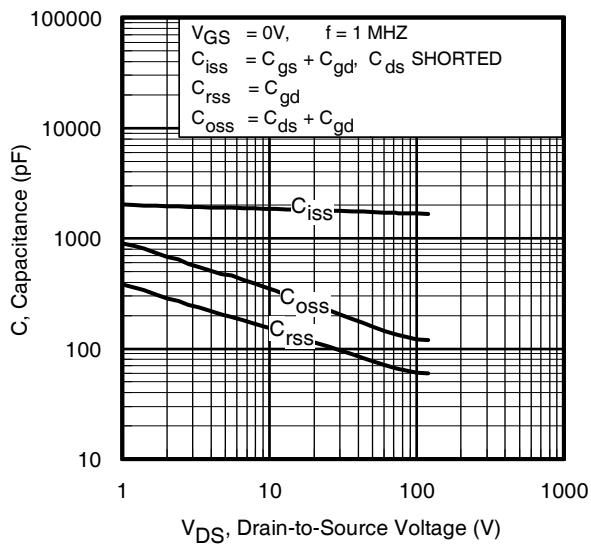


Fig 5. Typical Capacitance vs.
Drain-to-Source Voltage

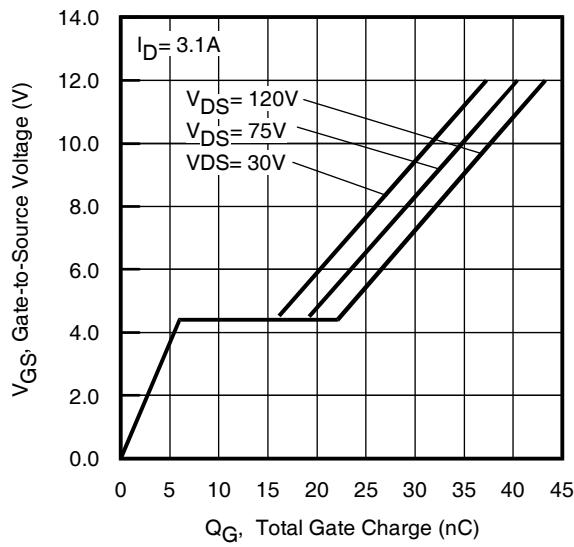


Fig 6. Typical Gate Charge vs.
Gate-to-Source Voltage

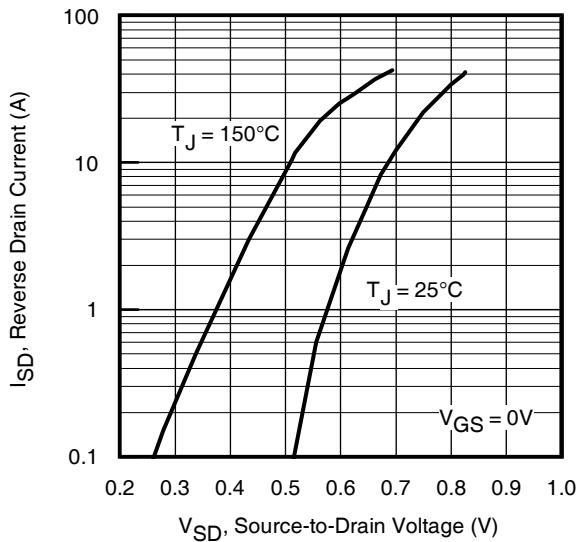


Fig 7. Typical Source-Drain Diode
Forward Voltage

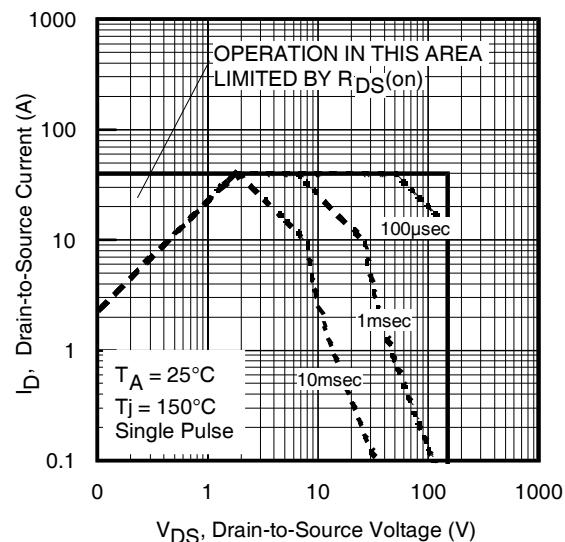


Fig 8. Maximum Safe Operating Area

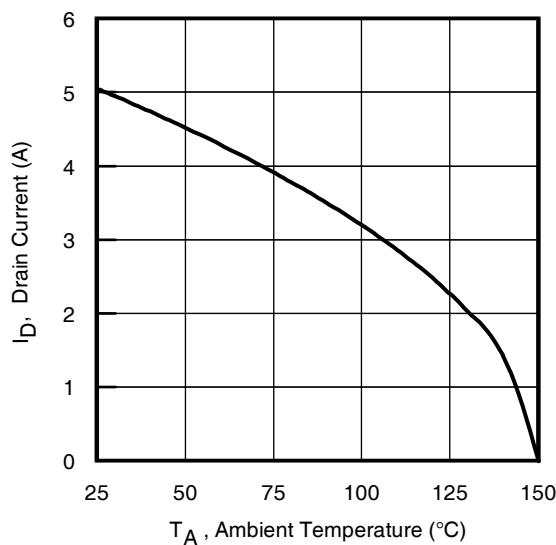


Fig 9. Maximum Drain Current vs.
Ambient Temperature

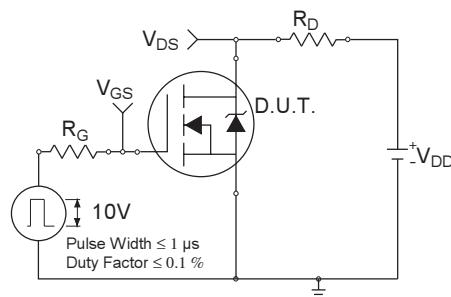


Fig 10a. Switching Time Test Circuit

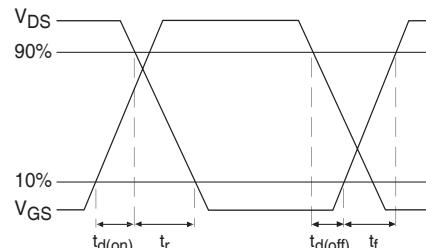


Fig 10b. Switching Time Waveforms

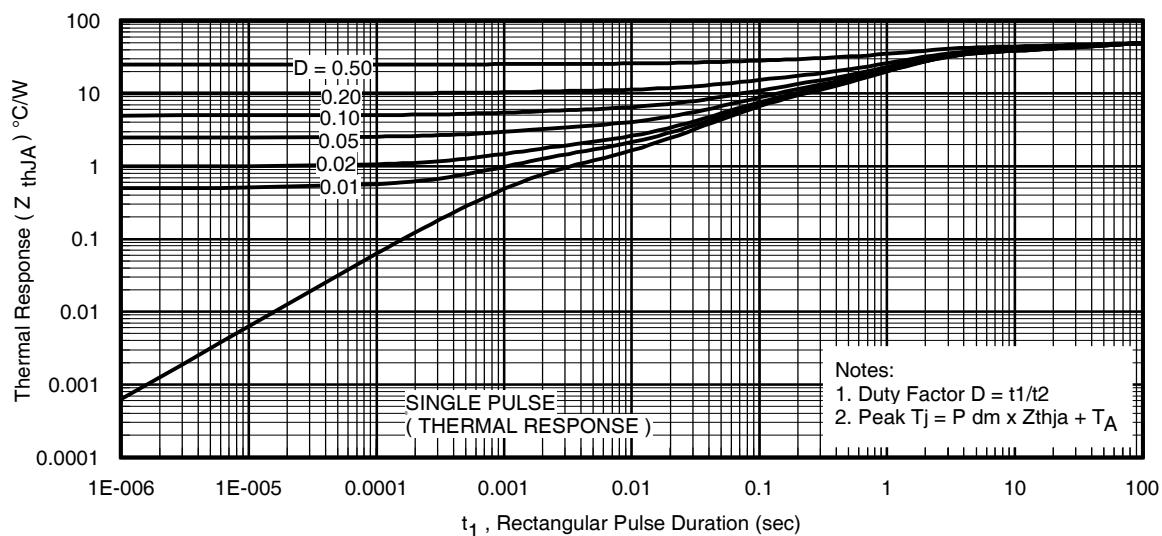


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

IRF7494PbF

International
IR Rectifier

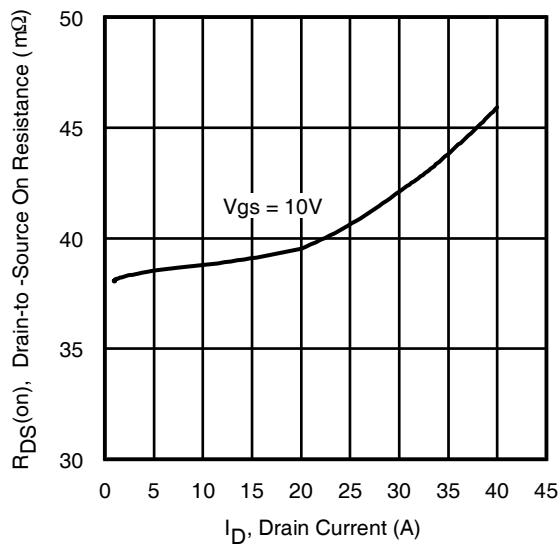


Fig 12. On-Resistance vs. Drain Current

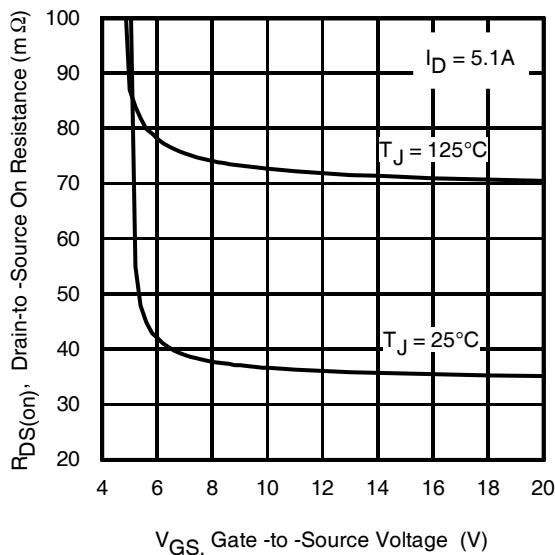


Fig 13. On-Resistance vs. Gate Voltage

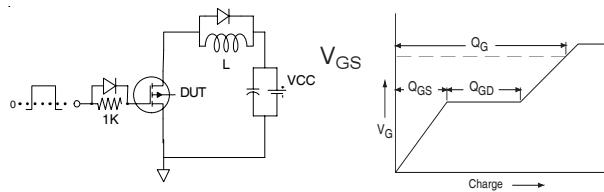


Fig 14a&b. Basic Gate Charge Test Circuit and Waveform

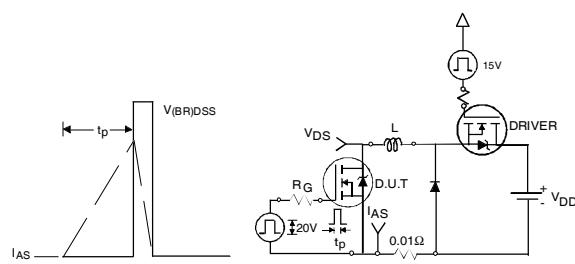


Fig 15a&b. Unclamped Inductive Test circuit and Waveforms

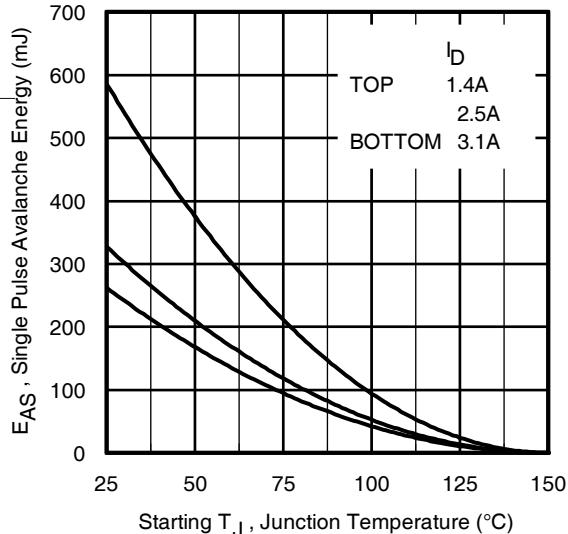
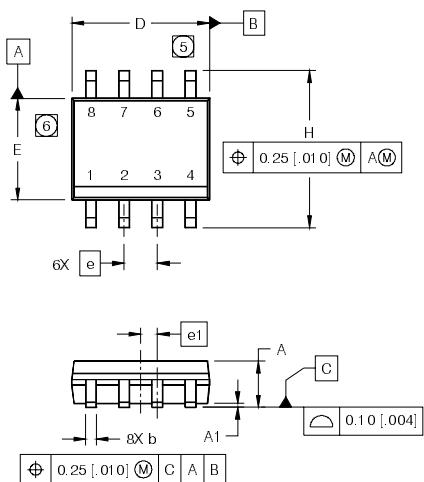


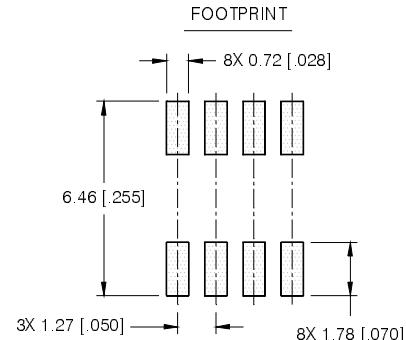
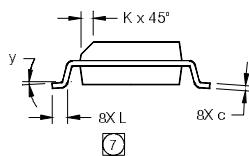
Fig 15c. Maximum Avalanche Energy vs. Drain Current

SO-8 Package Outline(Mosfet & Fetky)

Dimensions are shown in milimeters (inches)

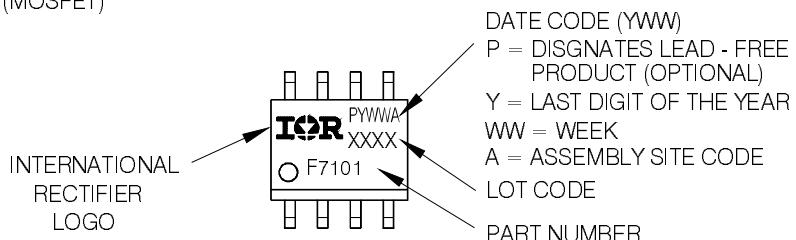


DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050	BASIC	1.27	BASIC
e1	.025	BASIC	0.635	BASIC
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
y	0°	8°	0°	8°



SO-8 Part Marking Information

EXAMPLE: THIS IS AN IRF7101 (MOSFET)



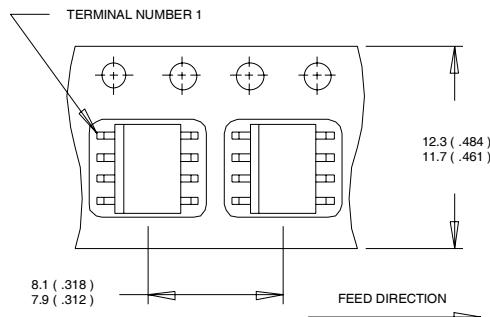
Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>
www.irf.com

IRF7494PbF

International
IR Rectifier

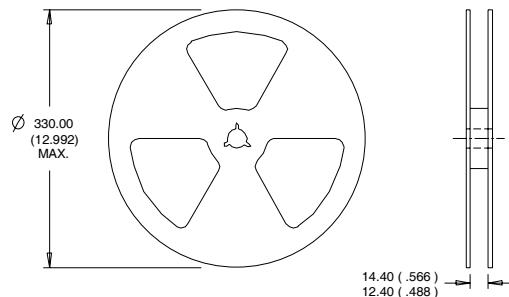
SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting $T_J = 25^\circ\text{C}$, $L = 55\text{mH}$, $R_G = 25\Omega$, $I_{AS} = 3.1\text{A}$.
- ③ When mounted on 1 inch square copper board, $t \leq 10$ sec.
- ④ Pulse width $\leq 400\mu\text{s}$; duty cycle $\leq 2\%$.
- ⑤ C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .
- ⑥ $I_{SD} \leq 3.1\text{A}$, $di/dt \leq 1907\text{A}/\mu\text{s}$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 150^\circ\text{C}$.
- ⑦ R_θ is measured at T_J of approximately 90°C .

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

Data and specifications subject to change without notice.
This product has been designed and qualified for the Consumer market.
Qualifications Standards can be found on IR's Web site.

International
IR Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105
TAC Fax: (310) 252-7903

Visit us at www.irf.com for sales contact information.10/2009

www.irf.com